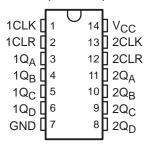
- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80-μA Max I<sub>CC</sub>
- Typical t<sub>pd</sub> = 13 ns
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Dual 4-Bit Binary Counters With Individual Clocks
- Direct Clear for Each 4-Bit Counter
- Can Significantly Improve System
   Densities by Reducing Counter Package
   Count by 50 Percent

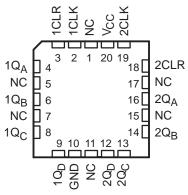
#### description/ordering information

The 'HC393 devices contain eight flip-flops and additional gating to implement two individual 4-bit counters in a single package. These devices comprise two independent 4-bit binary counters, each having a clear (CLR) and a clock (CLK) input. N-bit binary counters can be implemented with each package, providing the capability of divide by 256. The 'HC393 devices have parallel outputs from each counter stage so that any submultiple of the input count frequency is available for system timing signals.

#### SN54HC393 . . . J OR W PACKAGE SN74HC393 . . . D, DB, N, NS, OR PW PACKAGE (TOP VIEW)



# SN54HC393 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### **ORDERING INFORMATION**

TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN74HC393N	SN74HC393N
		Tube of 50	SN74HC393D	
	SOIC - D	Reel of 2500	SN74HC393DR	HC393
		Reel of 250	SN74HC393DT	
-40°C to 85°C	SOP - NS	Reel of 2000	SN74HC393NSR	HC393
	SSOP - DB	Reel of 2000	SN74HC393DBR	HC393
		Tube of 90	SN74HC393PW	
	TSSOP - PW	Reel of 2000	SN74HC393PWR	HC393
		Reel of 250	SN74HC393PWT	
	CDIP – J	Tube of 25	SNJ54HC393J	SNJ54HC393J
−55°C to 125°C	CFP – W	Tube of 150	SNJ54HC393W	SNJ54HC393W
	LCCC – FK	Tube of 55	SNJ54HC393FK	SNJ54HC393FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



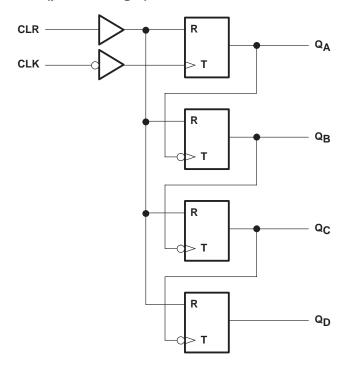
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FUNCTION TABLE COUNT SEQUENCE (each counter)

COUNT		OUTI	PUTS	
COUNT	$Q_{D}$	QC	$Q_{B}$	$Q_{A}$
0	L	L	L	L
1	L	L	L	Н
2	L	L	Н	L
3	L	L	Н	Н
4	L	Н	L	L
5	L	Н	L	Н
6	L	Н	Н	L
7	L	Н	Н	Н
8	Н	L	L	L
9	Н	L	L	Н
10	Н	L	Н	L
11	Н	L	Н	Н
12	Н	Н	L	L
13	Н	Н	L	Н
14	Н	Н	Н	L
15	Н	Н	Н	Н

## logic diagram, each counter (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub>		0.5	V to $7~V$
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see	ee Note 1)		±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CO</sub>	c) (see Note 1)		±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )			
Continuous current through V <sub>CC</sub> or GND			±50 mA
Package thermal impedance, $\theta_{\text{JA}}$ (see Note 2):	: D package		86°C/W
, <b>0</b> , ( ,	DB package		96°C/W
	N package		80°C/W
	NS package		76°C/W
	PW package	′	113°C/W
Storage temperature range, T <sub>stg</sub>	. •		

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 3)

			SN	SN54HC393		SN74HC393			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		2	5	6	2	5	6	V
		V <sub>CC</sub> = 2 V	1.5			1.5			
VIH	High-level input voltage	$V_{CC} = 4.5 \text{ V}$	3.15			3.15			V
		V <sub>CC</sub> = 6 V	4.2			4.2			
		V <sub>CC</sub> = 2 V			0.5			0.5	V
VIL	Low-level input voltage	$V_{CC} = 4.5 \text{ V}$			1.35			1.35	
		V <sub>CC</sub> = 6 V			1.8			1.8	
VI	Input voltage		0		VCC	0		VCC	V
Vo	Output voltage		0		VCC	0		VCC	V
		V <sub>CC</sub> = 2 V			1000			1000	
Δt/Δν†	Input transition rise/fall time	V <sub>CC</sub> = 4.5 V			500			500	ns
		VCC = 6 V			400			400	
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at VCC or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>†</sup> If this device is used in the threshold region (from V<sub>IL</sub>max = 0.5 V to V<sub>IH</sub>min = 1.5 V), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at t<sub>t</sub> = 1000 ns and V<sub>CC</sub> = 2 V does not damage the device; however, functionally, the CLK inputs are not ensured while in the shift, count, or toggle operating modes.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	ONDITIONS	Vaa	Т	A = 25°C	;	SN54H	C393	SN74H	C393	UNIT
PARAMETER	1251 CC	CNDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	1.9	1.998		1.9		1.9		
		I <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		4.4		
Voн	VI = VIH or VIL		6 V	5.9	5.999		5.9		5.9		V
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		1
		$I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		5.34		
			2 V		0.002	0.1		0.1		0.1	
		or $V_{IL}$ $I_{OL} = 20 \mu A$ $I_{OL} = 4 \text{ mA}$	4.5 V		0.001	0.1		0.1		0.1	
VOL	$V_I = V_{IH}$ or $V_{IL}$		6 V		0.001	0.1		0.1		0.1	V
			4.5 V		0.17	0.26		0.4		0.33	
		$I_{OL} = 5.2 \text{ mA}$	6 V		0.15	0.26		0.4		0.33	
lį	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA
Icc	$V_I = V_{CC}$ or 0,	I <sub>O</sub> = 0	6 V			8		160		80	μΑ
Ci		·	2 V to 6 V		3	10		10		10	pF

# timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			V	T <sub>A</sub> = 2	25°C	SN54H	C393	SN74H	C393	UNIT
			VCC	MIN	MAX	MIN	MAX	MIN	MAX	UNII
			2 V		6		4.2		5	
fclock	Clock frequency		4.5 V		31		21		25	MHz
			6 V		36		25		28	
		CLK high or low	2 V	80		120		100		
			4.5 V	16		24		20		
١.	Pulse duration		6 V	14		20		18		
t <sub>W</sub>	ruise duration	CLR high	2 V	80		120		100		ns
			4.5 V	16		24		20		7
			6 V	14		20		18		
t <sub>Su</sub> Setup time, CLR inactive		·	2 V	25		25		25		
			4.5 V	5		5		5		ns
			6 V	5		5		5		

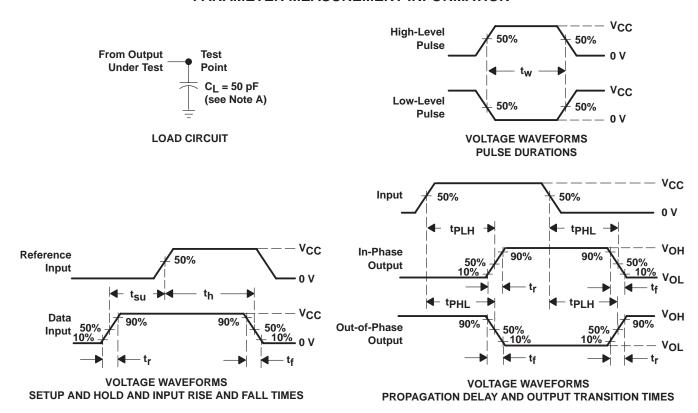
# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	,,	T,	T <sub>A</sub> = 25°C		SN54F	IC393	SN74H	IC393			
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT		
			2 V	6	10		4.2		5				
f <sub>max</sub>	CLK	$Q_A$	4.5 V	31	50		21		25		MHz		
			6 V	36	60		25		28				
			2 V		50	120		180		150			
		$Q_A$	4.5 V		15	24		36		30			
			6 V		13	20		31		26			
			2 V		72	190		285		240			
	CLK	Q <sub>B</sub>	4.5 V		22	38		57		47	ns		
			6 V		18	32		48		40			
<sup>t</sup> pd	OLK		2 V		91	240		360		300	113		
				QC	4.5 V		28	48		72		60	
			6 V		22	41		61		51			
		QD	2 V		100	290		430		360			
			4.5 V		32	58		87		72			
			6 V		24	50		74		62			
			2 V		45	165		250		205			
t <sub>PHL</sub>	CLR	Any	4.5 V		17	33		49		41	ns		
			6 V		14	28		42		35			
			2 V		28	75		110		95			
t <sub>t</sub>		Any	4.5 V		8	15		22		19	ns		
			6 V		6	13		19		16			

## operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER		TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per counter	No load	40	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_Q = 50 \Omega$ ,  $t_f = 6$  ns,  $t_f = 6$  ns.
- C. For clock inputs,  $f_{\mbox{\scriptsize max}}$  is measured when the input duty cycle is 50%.
- D. The outputs are measured one at a time with one input transition per measurement.
- E.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

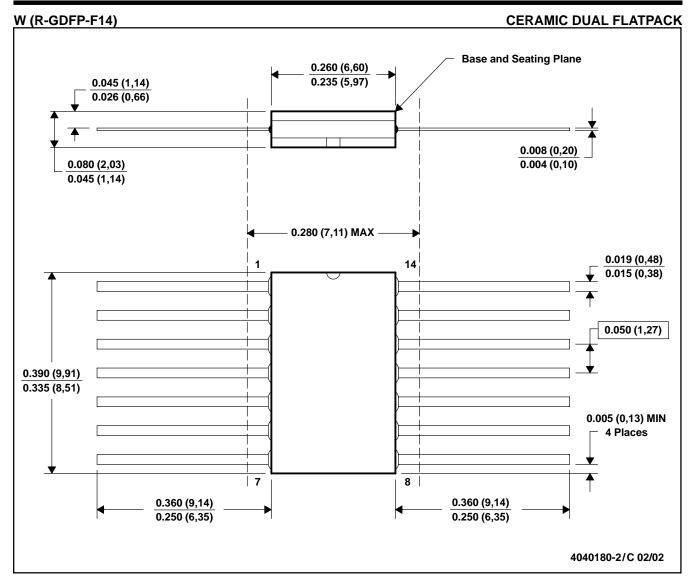
Figure 1. Load Circuit and Voltage Waveforms



## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



## D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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